



# TDM3083 Zero Volt Switching

RoHS Extern

800V Triac Driver

# Description

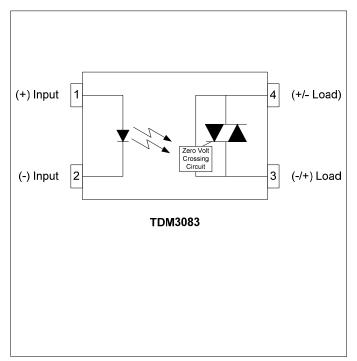
The TDM3083 consists of a single input LED optically coupled to a zero-volt crossing high voltage triac driver. The TDM3083 provides high input-to-output isolation and is designed to drive high-powered triacs. The TDM3083 provides an optically isolated method of interfacing logic level control signals to equipment powered from AC lines rated at 240V and higher.

The TDM3083 comes standard in a miniature 4 pin SOP package.

# Applications

- Home Appliances
- Motor / Drive Controls
- Solid State Relays
- Solenoid / Valve Controls
- Temperature Controls

# Schematic Diagram



## Features

- Ultra Miniature 4-Pin Small Outline Package
- Zero Volt Switching
- 800V Blocking Voltage
- Low Trigger Current (5mA MAX)
- High Input-to-Output Isolation (3.75kV<sub>RMS</sub>)
- Long Life / High Reliability
- RoHS / Pb-Free / REACH Compliant

### Agency Approvals

UL / C-UL:	File # E201932
VDE:	File # 40035191 (EN 60747-5-2)

# **Absolute Maximum Ratings**

The values indicated are absolute stress ratings. Functional operation of the device is not implied at these or any conditions in excess of those defined in electrical characteristics section of this document. Exposure to absolute Maximum Ratings may cause permanent damage to the device and may adversely affect reliability.

Storage Temperature	55 to +125°C
Operating Temperature	40 to +100°C
Continuous Input Current	50mA
Transient Input Current	500mA
Reverse Input Control Voltage	5V
Input Power Dissipation	70mW
Total Power Dissipation	170mW
Solder Temperature – Wave (10sec)	260°C
Solder Temperature – IR Reflow (10sec)	260°C

# **Ordering Information**

Part Number	Description
TDM3083	4 pin SOP, (100/Tube)
TDM3083-TR	4 pin SOP, Tape and Reel (2000/Reel)

NOTES: Suffixes listed above are not included in marking on device for part number identification



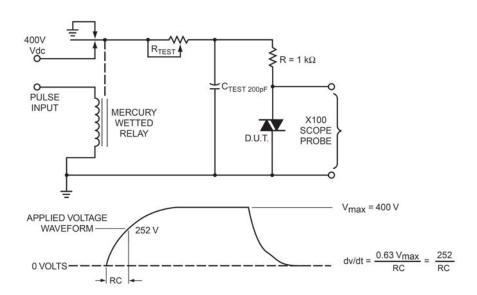
#### Electrical Characteristics, T<sub>A</sub> = 25°C (unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Input Specifications						
LED Forward Voltage	V <sub>F</sub>	-	1.4	1.8	V	I <sub>F</sub> = 10mA
LED Reverse Voltage	BV <sub>R</sub>	5	-	-	V	I <sub>R</sub> = 10μΑ
Reverse Leakage Current	I <sub>InRleak</sub>	-	-	10	μA	V <sub>R</sub> = 6µA
Trigger Current <sup>1</sup>	I <sub>FT</sub>	-	-	5	mA	Main Terminal Voltage = 3V
Output Specifications						
Blocking Voltage	V <sub>DRM</sub>	800	-	-	V	I <sub>0</sub> = 1μA
Peak Blocking Current	I <sub>DRM1</sub>	-	60	500	nA	V <sub>DRM</sub> = 800V
On-State Voltage	V <sub>ON</sub>	-	1.8	3	V	I <sub>F</sub> = 5mA, I <sub>TM</sub> = 100mA
Leakage Current	I <sub>DRM2</sub>	-	0.2	1	μA	I <sub>F</sub> =0mA, V <sub>DRM</sub> = 800V
Holding Current	I <sub>HOLD</sub>	-	100	-	μA	-
Inhibit Voltage	V <sub>INH</sub>	-	5	20	V	I <sub>F</sub> = 5mA
Critical Rate of Rise <sup>2</sup>	dV/dt	1,000	2,000	-	V/µS	-
Isolation Specifications						
Isolation Voltage	V <sub>ISO</sub>	3,750	-	-	$V_{\text{RMS}}$	RH ≤ 50%, t=1min
Input-Output Resistance	R <sub>I-O</sub>	-	10 <sup>12</sup>	-	Ω	$V_{I-O} = 500 V_{DC}$

Note 1: Resistive load. For inductive loads, higher drive current is recommended

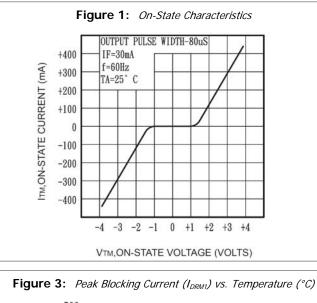
Note 2: This is for static dV/dt. Test Circuit Below

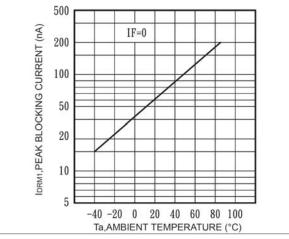
# TDM3083 Static dV/dt Test Circuit:

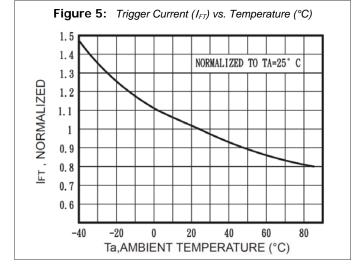


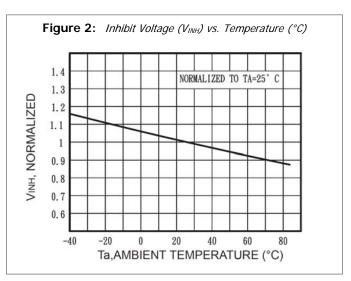


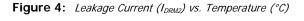
#### TDM3083 Performance & Characteristics Plots, T<sub>A</sub> = 25°C (unless otherwise specified)

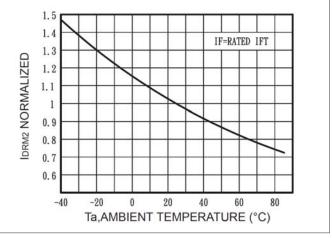










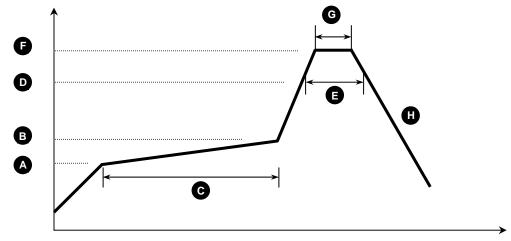




#### TDM3083 Solder Reflow Temperature Profile Recommendations

#### (1) Infrared Reflow:

Refer to the following figure as an example of an optimal temperature profile for single occurrence infrared reflow. Soldering process should not exceed temperature or time limits expressed herein. Surface temperature of device package should not exceed 250°C:



Process Step	Description	Parameter	
А	Preheat Start Temperature (°C)	150°C	
В	Preheat Finish Temperature (°C)	180°C	
С	Preheat Time (s)	90 - 120s	
D	Melting Temperature (°C)	230°C	
E	Time above Melting Temperature (s)	30s	
F	Peak Temperature, at Terminal (°C)	260°C	
G	Dwell Time at Peak Temperature (s)	10s	
H	Cool-down (°C/s)	<6°C/s	

#### (2) Wave Solder:

Maximum Temperature:	260°C (at terminal)
Maximum Time:	10s
Pre-heating:	100 - 150°C (30 - 90s)
Single Occurrence	

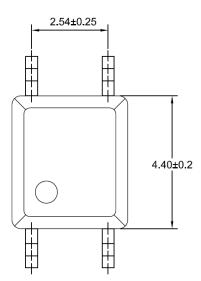
(3) Hand Solder:

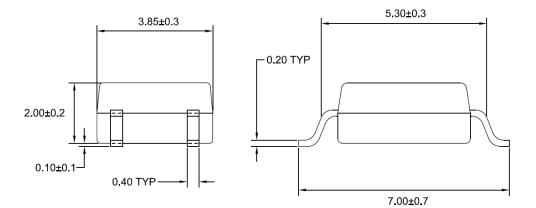
Maximum Temperature: Maximum Time:	350°C 3s	(at tip of soldering iron)
Single Occurrence		



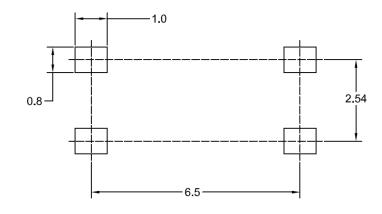
### **TDM3083 Package Dimensions**

### 4 PIN SOP Package





4 PIN SOP Footprint



**Note:** All dimensions in millimeters [mm]

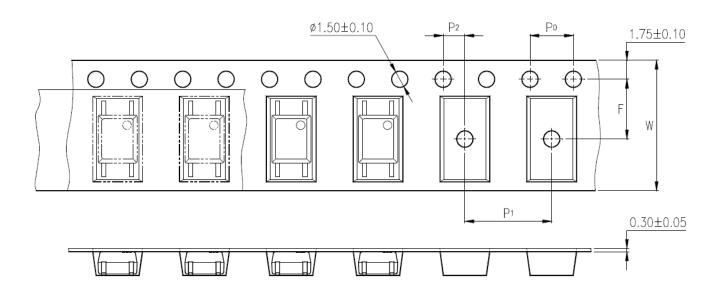


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# **TDM3083 Packaging Specifications**

Tape & Reel Specifications (T&R)

Note: All dimensions in millimeters [mm]



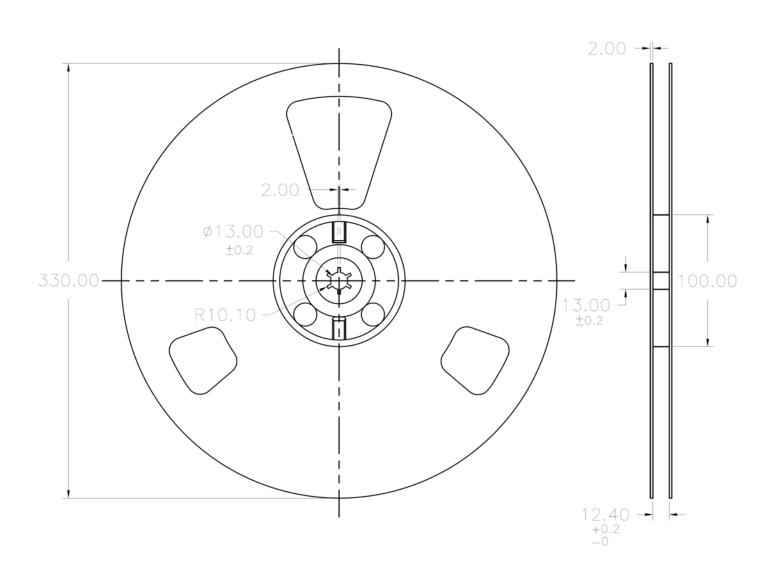
Specification	Symbol	Dimensions, mm ( inches )
Tape Width	W	$12 \pm 0.3$ ( $0.47$ )
Sprocket Hole Pitch	P0	4 ± 0.1 ( 0.15 )
Compartment Location	F P2	$\begin{array}{c} 5.5\pm 0.1 \;(\; 0.217\;) \\ 2\pm 0.1 \;(\; 0.079\;) \end{array}$
Compartment Pitch	P1	8 ± 0.1 ( 0.315 )



### **TDM3083 Packaging Specifications**

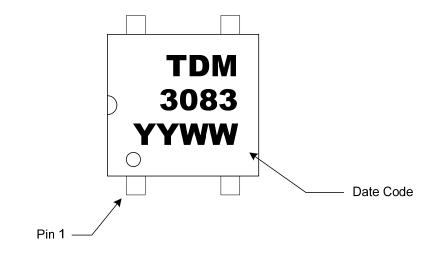
Tape & Reel Specifications (T&R)

**Note:** All dimensions in millimeters [mm]





#### **TDM3083 Package Marking**



### **TDM3083 Package Weights**

Device	Single Unit	Full Tube (100pcs)	Full Pouch (10 tubes)	Full Reel (2000pcs)
TDM3083	0.10	23	240	-
TDM3083-TR	0.10	-	-	500

**Note:** All weights above are in GRAMS, and include packaging materials where applicable

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